ITCH27015E2



700MHz-2700MHz, 15W, 28V RF Power LDMOS FETs

Description

The ITCH27015E2 is a 15-watt, internally matched LDMOS FET, designed for cellular base station and ISM applications with frequencies from 700MHz to 2700 MHz

• Typical Performance (On Innogration fixture with device soldered):

 V_{DD} = 28 Volts, I_{DQ} = 100 mA, Pulse Width =10us, Duty Cycle =12%.

Frequency	O (-ID)	P_1dB	η _D	P_3dB	η _D
(MHz)	Gp (dB)	(dBm)	(%)	(dBm)	(%)
2620	19.8	42.5	56	43.5	59
2655	20	42	56	43.3	60
2690	19.9	41.6	55	42.9	61

• Typical Performance (On Innogration fixture with device soldered):

 V_{DD} = 28 Volts, I_{DQ} = 100 mA, Pulse Width =50us, Duty Cycle =20%.

Frequency	Co (dD)	P_1dB	η _D	P_3dB	η _D
(MHz)	Gp (dB)	(dBm)	(%)	(dBm)	(%)
2400	19.4	43.0	57	44.0	61
2450	19.7	42.3	57	43.5	62
2500	19.9	41.7	57	42.8	61

Highlight: The fixture is used same board different BOM.

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Internally Matched for Ease of Use
- · Excellent thermal stability, low HCI drift

- Large Positive and Negative Gate/Source Voltage Range
- Pb-free, RoHS-compliant

for Improved Class C Operation

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+65	Vdc
GateSource Voltage	V _{GS}	-10 to +10	Vdc
Operating Voltage	V _{DD}	+32	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T _c	+150	°C
Operating Junction Temperature	T,	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Polo	2	0000
T _C = 85°C, T _J =200°C, DC test	Rejc	2	°C/W

Table 3. ESD Protection Characteristics

Test Methodology	Class
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Document Number: ITCH27015E2 Preliminary Datasheet V2.0

Human Body Model (per JESD22--A114) Class 2

Table 4. Electrical Characteristics (TA = 25°C unless otherwise noted)

DC Characteristics

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	V _{GS} =0V; I _{DS} =100uA	V _{DSS}	65			V
Zero Gate Voltage Drain Leakage	V _{DS} = 28 V, V _{GS} = 0 V	1			1	^
Current		I _{DSS}			'	μΑ
GateSource Leakage Current	$V_{GS} = 9 \text{ V}, V_{DS} = 0 \text{ V}$	I _{GSS}			1	μΑ
Gate Threshold Voltage	$V_{DS} = 28V, I_D = 300 \mu A$	V _{GS} (th)		1.75		V
Gate Quiescent Voltage	$V_{DS} = 28 \text{ V}, I_{DS} = 100 \text{ mA},$	V		2.65		\/
	Measured in Functional Test	$V_{GS(Q)}$		2.65		V

Pulse CW Signal performance (In Innogration Test Fixture, 50 ohm system): $V_{DD} = 28 \text{ Vdc}$, $I_{DQ} = 100 \text{ mA}$, f = 2690 MHz, Pulse CW, Pulse Width =10us, Duty Cycle =12%.

Characteristic	Symbol	Min	Тур	Max	Unit
Power Gain	Gp		19.9		dB
Drain Efficiency@P3dB	$\eta_{\scriptscriptstyle D}$		61		%
3dB Compression Point	P _{-3dB}		42.9		dBm
Input Return Loss	IRL		-10		dB

Load Mismatch (In Innogration Test Fixture, 50 ohm system): $V_{DD} = 28 \text{ Vdc}$, $I_{DQ} = 100 \text{ mA}$, f = 2690 MHz

VSWR 10:1 at 15W Pulsed CW Output Power	No Device Degradation
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TYPICAL CHARACTERISTICS

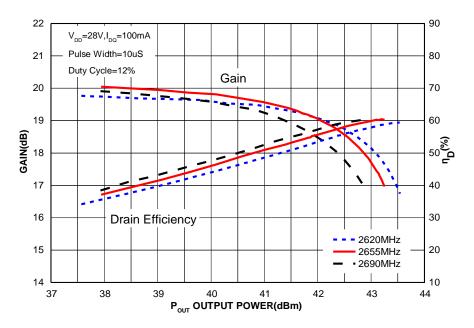


Figure 1. Power gain and drain efficiency as function of Pulse output power (2620-2690MHz)

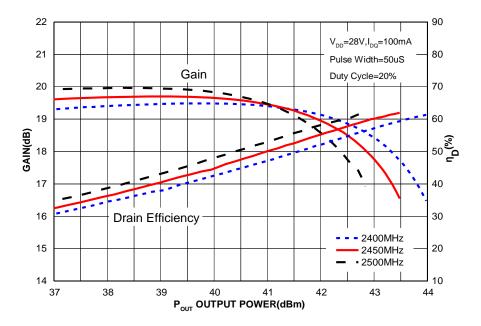
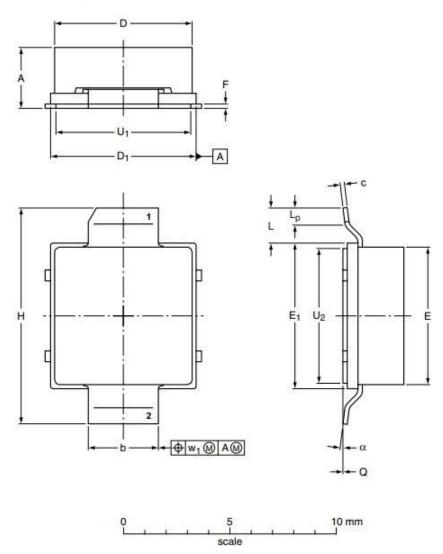


Figure 2. Power gain and drain efficiency as function of Pulse output power (2400-2500MHz)

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Package Outline

Earless Flanged ceramic package; 2 leads



UNIT	Α	b	С	D	D_1	E	E ₁	F	Н	L	L_{P}	Q	Uı	U ₂	W ₁	α
mm	3.63	3.38	0.23	6.55	6.93	6.55	6.93	0.23	10.29	1.65	1.02	+0.05	6.43	6.43	0.51	7°
mm	3.05	3.23	0.18	6.40	6.78	6.40	6.78	0.18	10.03	1.00	0.51	-0.05	6.27	6.27	0.51	0°
inches	0.143	0.133	0.009	0.258	0.273	0.258	0.273	0.009	0.405	0.005	0.040	+0.002	0.253	0.253	0.00	7°
inches	0.120	0.127	0.007	0.252	0.267	0.252	0.267	0.007	0.395	0.065	0.020	-0.002	0.247	0.247	0.02	0°

OUTLINE		REFE	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	IOOOL DATE
PKG-E-A						10/22/2013

Document Number: ITCH27015E2 Preliminary Datasheet V2.0

Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2017/02/06	Rev 1.0	Preliminary Datasheet
2017/03/16	Rev 2.0	Preliminary Datasheet

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